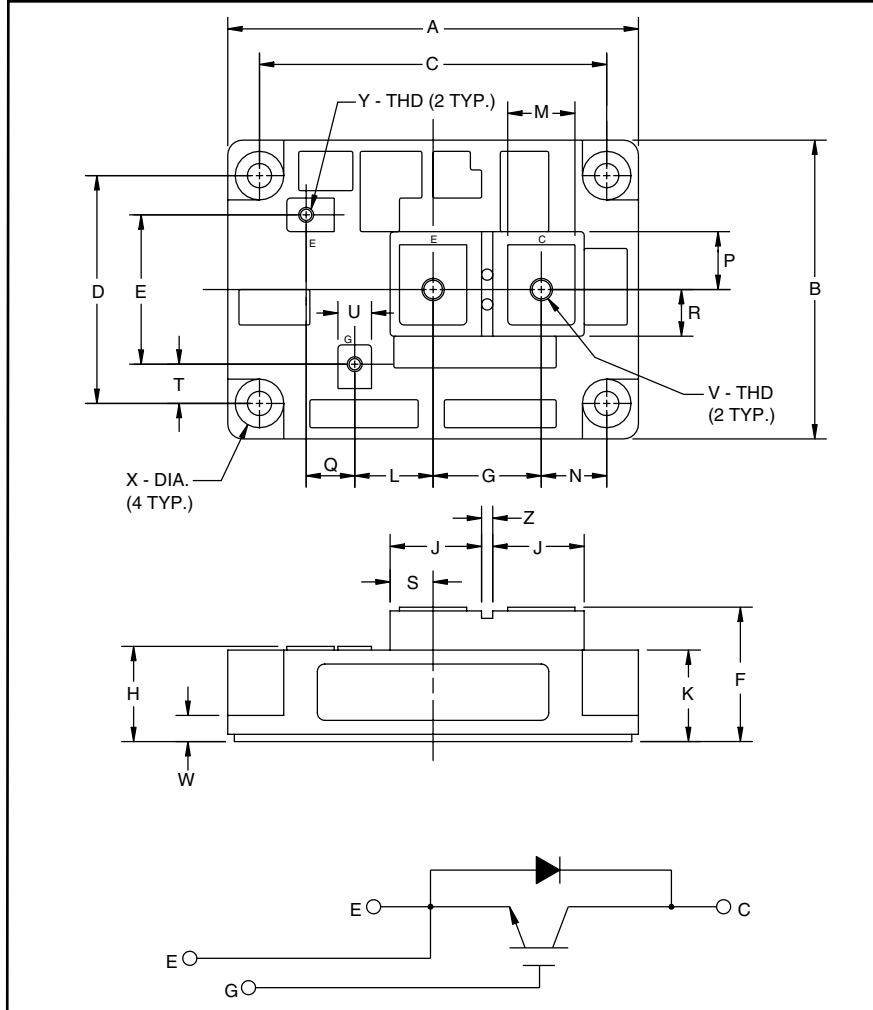


Single IGBTMOD™ A-Series Module 600 Amperes/1200 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.33	110.0
B	3.15	80.0
C	3.66±0.008	93.0±0.25
D	2.44±0.008	62.0±0.25
E	1.57	40.0
F	1.42 Max.	36.0 Max.
G	1.14	29.0
H	1.00 Max.	25.5 Max
J	0.94	24.5
K	0.94	24.5
L	0.83	21.0
M	0.71	18.0

Dimensions	Inches	Millimeters
N	0.69	17.5
P	0.61	15.5
Q	0.51	13.0
R	0.49	12.5
S	0.45	11.5
T	0.43	11.0
U	0.35	9.0
V	M8 Metric	M8
W	0.28	7.0
X	0.256 Dia.	6.50 Dia.
Y	M4 Metric	M4
Z	0.12	3.04



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of one IGBT Transistor in a single configuration with a reverse connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- ☐ Low Drive Power
- ☐ Low $V_{CE(sat)}$
- ☐ Discrete Super-Fast Recovery Free-Wheel Diode
- ☐ Isolated Baseplate for Easy Heat Sinking

Applications:

- ☐ DC Chopper
- ☐ Inverter
- ☐ UPS
- ☐ Forklift

Ordering Information:

Example: Select the complete part module number you desire from the table below - i.e. CM600HB-24A is a 1200V (V_{CES}), 600 Ampere Single IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	600	24

CM600HB-24A
Single IGBTMOD™ A-Series Module
 600 Amperes/1200 Volts

Absolute Maximum Ratings, $T_j = 25^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM600HB-24A	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E Short)	V_{CES}	1200	Volts
Gate-Emitter Voltage (C-E Short)	V_{GES}	± 20	Volts
Collector Current (DC, $T_C = 83^\circ\text{C}^*$)	I_C	600	Amperes
Peak Collector Current	I_{CM}	1200**	Amperes
Emitter Current*** ($T_C = 25^\circ\text{C}$)	I_E	600	Amperes
Peak Emitter Current***	I_{EM}	1200**	Amperes
Maximum Collector Dissipation ($T_C = 25^\circ\text{C}^*$, $T_j \leq 150^\circ\text{C}$)	P_C	3670	Watts
Mounting Torque, M6 Main Terminal	—	40	in-lb
Mounting Torque, M6 Mounting	—	40	in-lb
Mounting Torque, M4 G(E) Terminal	—	15	in-lb
Weight	—	560	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{ISO}	2500	Volts

Static Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}$, $V_{GE} = 0\text{V}$	—	—	1.0	mA
Gate Leakage Current	I_{GES}	$V_{GE} = V_{GES}$, $V_{CE} = 0\text{V}$	—	—	0.5	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 60\text{mA}$, $V_{CE} = 10\text{V}$	6.0	7.0	8.0	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 600\text{A}$, $V_{GE} = 15\text{V}$, $T_j = 25^\circ\text{C}$	—	2.1	3.0	Volts
		$I_C = 600\text{A}$, $V_{GE} = 15\text{V}$, $T_j = 125^\circ\text{C}$	—	2.4	—	Volts
Total Gate Charge	Q_G	$V_{CC} = 600\text{V}$, $I_C = 600\text{A}$, $V_{GE} = 15\text{V}$	—	3000	—	nC
Emitter-Collector Voltage**	V_{EC}	$I_E = 600\text{A}$, $V_{GE} = 0\text{V}$	—	—	3.8	Volts

Dynamic Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C_{ies}	$V_{CE} = 10\text{V}$, $V_{GE} = 0\text{V}$	—	—	105	nF
Output Capacitance	C_{oes}		—	—	9	nF
Reverse Transfer Capacitance	C_{res}		—	—	2.0	nF
Inductive	Turn-on Delay Time	$V_{CC} = 600\text{V}$, $I_C = 600\text{A}$, $V_{GE1} = V_{GE2} = 15\text{V}$, $R_G = 0.52\Omega$, Inductive Load	—	—	660	ns
Load	Rise Time		—	—	190	ns
Switch	Turn-off Delay Time		—	—	700	ns
Time	Fall Time		—	—	350	ns
Diode Reverse Recovery Time***	t_{rr}	Switching Operation,	—	—	250	ns
Diode Reverse Recovery Charge***	Q_{rr}	$I_E = 600\text{A}$	—	19.0	—	μC

* T_C , T_f measured point is just under the chips.

**Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed $T_{j(max)}$ rating.

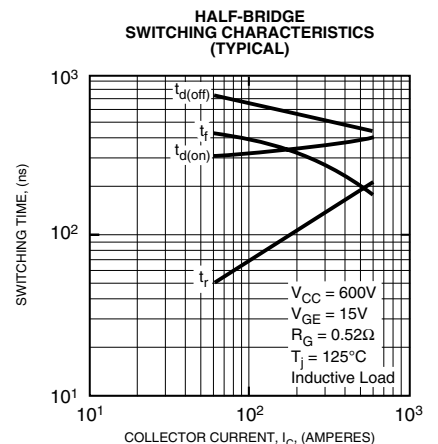
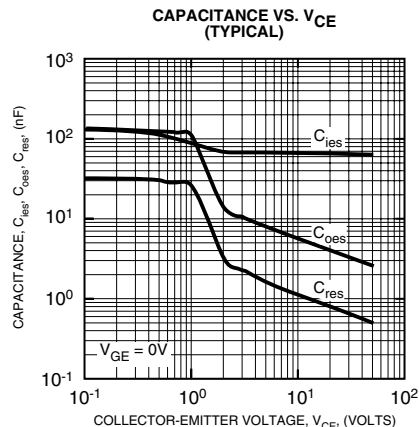
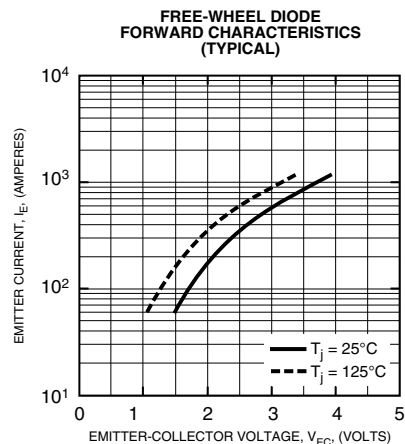
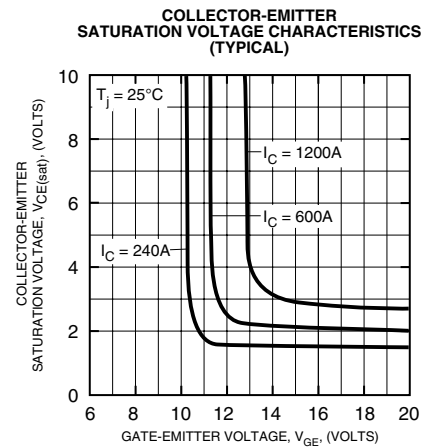
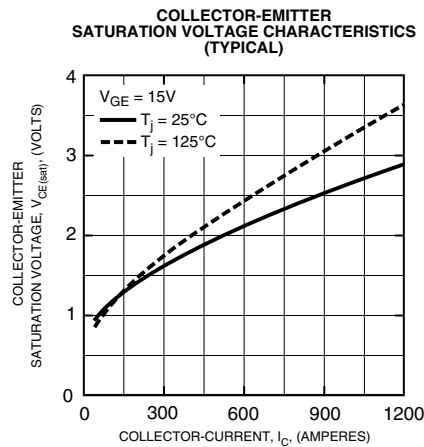
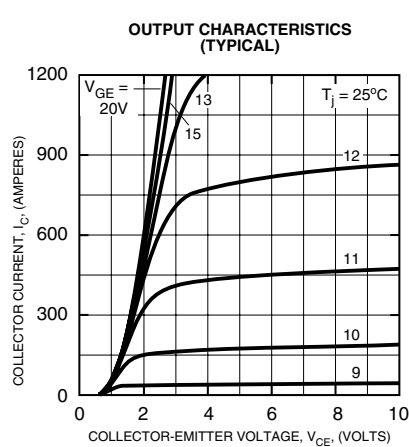
***Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

CM600HB-24A
Single IGBTMOD™ A-Series Module
 600 Amperes/1200 Volts

Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case*	$R_{th(j-c)Q}$	Per IGBT 1/2 Module, T_C Reference Point per Outline Drawing	—	—	0.034	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case*	$R_{th(j-c)D}$	Per FWDi 1/2 Module, T_C Reference Point per Outline Drawing	—	—	0.051	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per 1/2 Module, Thermal Grease Applied	—	0.02	—	$^\circ\text{C/W}$
External Gate Resistance	R_G		0.52	—	7.8	Ω

* T_C , T_f measured point is just under the chips.



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